### PATENT ASSIGNMENT COVER SHEET

Electronic Version v1.1 Stylesheet Version v1.2 EPAS ID: PAT5481764

SUBMISSION TYPE:	NEW ASSIGNMENT
NATURE OF CONVEYANCE:	ASSIGNMENT

#### **CONVEYING PARTY DATA**

Name	Execution Date
AKIRA ONO	01/28/2019
HIROKAZU HASHIMOTO	03/08/2019
HIROSHI UJI	01/31/2019

#### **RECEIVING PARTY DATA**

Name:	SONY CORPORATION
Street Address:	1-7-1 KONAN
Internal Address:	MINATO-KU
City:	TOKYO
State/Country:	JAPAN
Postal Code:	1080075
Name:	SONY SEMICONDUCTOR SOLUTIONS CORPORATION
Street Address:	4-14-1 ASAHI-CHO
Internal Address:	ATSUGI-SHI
City:	KANAGAWA
State/Country:	JAPAN
Postal Code:	2430014

#### **PROPERTY NUMBERS Total: 1**

Property Type	Number
Application Number:	16328066

#### **CORRESPONDENCE DATA**

**Fax Number:** (312)803-4960

Correspondence will be sent to the e-mail address first; if that is unsuccessful, it will be sent using a fax number, if provided; if that is unsuccessful, it will be sent via US Mail.

and the second s

**Email:** docketing@chiplawgroup.com

Correspondent Name: CHIP LAW GROUP
Address Line 1: 155 N WACKER DR

Address Line 2: SUITE 4250

Address Line 4: CHICAGO, ILLINOIS 60606

ATTORNEY DOCKET NUMBER: SP366929US00

NAME OF SUBMITTER:	PRAMOD CHINTALAPOODI
SIGNATURE:	/Pramod Chintalapoodi/
DATE SIGNED:	04/18/2019
Total Attachments: 3	
LOUIZO SERREDONISON DOONO	aign#paged tif

source=SP366929US00\_DecAssign#page1.tif source=SP366929US00\_DecAssign#page2.tif source=SP366929US00\_DecAssign#page3.tif

## DECLARATION (37 CFR 1.63) FOR UTILITY OR DESIGN APPLICATION USING AN APPLICATION DATA SHEET (37 CFR 1.76) AND ASSIGNMENT FOR MULTIPLE ASSIGNEES

Title of Information PRESENTATION APPARATUS, STEERING APPARATUS, AND INFORMATION PRESENTATION METHOD
As the below named inventor, I hereby declare that:
This declaration  is directed to:  The attached application, or
United States application or PCT international application number PCT/JP2017/029610  filed on 2017/08/18
The above-identified application was made or authorized to be made by me.
I believe that I am the original inventor or an original joint inventor of a claimed invention in the application.  SONY CORPORATION
WHEREAS, SONY SEMICONDUCTOR SOLUTIONS CORPORATION , with offices at
1-7-1 KONAN, MINATO-KU, TOKYO, 108-0075, JAPAN, 4-14-1 Asahi-cho, Atsugi-shi, Kanagawa, Japan
respectively (hereinafter referred to as ASSIGNEES), are desirous of jointly acquiring all interest in, to and under said invention, said application disclosing the invention and in, to and under any Letters Patent or similar legal protection which may be granted therefor in the United States and in any and all foreign countries;
NOW THEREFORE, in consideration of the sum of One Dollar (\$1.00), and other good and valuable consideration, the receipt and sufficiency of which are hereby acknowledged. I by these presents do hereby assign, sell and transfer anto said ASSIGNEES, their successors, assigns, and legal representatives, the entire right, title and interest in said invention, said application, including any divisions and continuations thereof, and in and to any and all Letters Patent of the United States, and countries foreign thereto, which may be granted for said invention, and in and to any and all priority rights and/or convention rights under the International Convention for the Protection of Industrial Property, Inter-American Convention Relating to Patents, Designs and Industrial Models, and any other international agreements to which the United States of America adheres, and to any other benefits accruing or to accrue to me with respect to the filling of applications for patents or securing of patents in the United States and countries foreign thereto, and I hereby authorize and request the Commissioner of Patents to issue said United States Letters Patent to said ASSIGNEES, as the assignees of the whole right, title and interest thereto;
And I further agree to execute all necessary or desirable and lawful future documents, including assignments in favor of said ASSIGNEES or their designee(s), as ASSIGNEES or their successors, assigns and legal representatives may from time-to-time present to me and without further remuneration, in order to perfect title in said invention, modifications, and improvements in said invention, applications and Letters Patent of the United States and countries foreign thereto;
And I further agree to properly execute and deliver and without further remuneration, such necessary or desirable and lawful papers for application for foreign patents, for filing subdivisions of said application for patent, and or, for obtaining any reissue or reissues of any Letters patent which may be granted for my aforesaid invention, as said ASSIGNEES thereof shall hereafter require and prepare at their own expense;
And I further agree that ASSIGNEES will, upon their request, be provided promptly with all pertinent facts and documents relating to said application, said invention and said Letters Patent and legal equivalents in foreign countries as may be known and accessible to me and will testify as to the same in any interference or litigation related thereto;
And I hereby covenant that no assignment, sale, agreement or encumbrance has been or will be made or entered into which would conflict with this assignment and sale.
I hereby acknowledge that any willful false statement made in this declaration is punishable under 18 U.S.C. 1001 by fine or imprisonment of not more than five (5) years, or both.
LEGAL NAME OF INVENTOR
Inventor: AKIRA ONO Date: January 25, 20/9
Signisture: A/S/M ONV

Attorney Docket No.: Suny Ref. No.: SP366929US00

# DECLARATION (37 CFR 1.63) FOR UTILITY OR DESIGN APPLICATION USING AN APPLICATION DATA SHEET (37 CFR 1.76) AND ASSIGNMENT FOR MULTIPLE ASSIGNEES

	Title of Invention	INFORMATION PRESENTATION APPARATUS, STEERING APPARATUS, AND INFORMATION PRESENTATION METHOD
	As the below	numed inventor, I hereby declare that:
	This declaration is directed to:	On The attached application, or
		United States application or PCT international application number PCT/JP2017/029610 filed on 2017/08/18
	The above-ide	entified application was made or authorized to be made by me.
	I believe that I	am the original inventor or an original joint inventor of a claimed invention in the application. SONY CORPORATION
	1-7-1 KON	SONY SEMICONDUCTOR SOLUTIONS CORPORATION  JAN, MINATO-KU, TOKYO, 108-0075, JAPAN,  thi-cho, Atsugi-shi, Kanagawa, Japan
	respectively application dis	(hereinafter referred to as ASSIGNEES), are desirous of jointly acquiring all interest in, to and under said invention, said solosing the invention and in, to and under any Letters Patent or similar legal protection which may be granted therefor in the and in any and all foreign countries:
	of which are hilegal represent in and to any a and all price convention Readheres, and to United States a	FORE, in consideration of the sum of One Dollar (\$1.00), and other good and valuable consideration, the receipt and sufficiency ereby acknowledged. I by these presents do hereby assign, sell and transfer unto said ASSIGNEES, their successors, assigns, and ratives, the entire right, title and interest in said invention, said application, including any divisions and continuations thereof, and and all Letters Patent of the United States, and countries foreign thereto, which may be granted for said invention, and in and to ority rights and/or convention rights under the International Convention for the Protection of Industrial Property. Inter-American dating to Patents, Designs and Industrial Models, and any other international agreements to which the United States of America or any other benefits accruing or to accrue to me with respect to the filing of applications for patents or securing of patents in the and countries foreign thereto, and I hereby authorize and request the Commissioner of Patents to issue said United States Letters ASSIGNEES, as the assignees of the whole right, title and interest thereto;
	lheir designee( further remune	igree to execute all necessary or desirable and lawful future documents, including assignments in favor of said ASSIGNEES or (s), as ASSIGNEES or their successors, assigns and legal representatives may from time-to-time present to me and without pration, in order to perfect title in said invention, modifications, and improvements in said invention, applications and Letters inited States and countries foreign thereto,
	application for	agree to properly execute and deliver and without further remuneration, such necessary or desirable and lawful papers for foreign patents, for filing subdivisions of said application for patent, and or, for obtaining any reissue or reissues of any Letters has be granted for my aforesaid invention, as said ASSIGNEES thereof shall hereafter require and prepare at their own expense,
	application, sai	agree that ASSIGNEES will, upon their request, be provided promptly with all pertinent facts and documents relating to said id invention and said Letters Patent and legal equivalents in foreign countries as may be known and accessible to me and will same in any interference or litigation related thereto;
	And I hereby o his assignment	ovenant that no assignment, sale, agreement or encumbrance has been or will be made or entered into which would conflict with tand sale.
-	hereby ackno of more than f	wledge that any willful false statement made in this declaration is punishable under 18 U.S.C. 1001 by fine or imprisonment of ive (5) years, or both,
•	~~~~~~~~~~	S OF INVENTOR
}	nventor:I	HIROKAZU HASHIMOTO Date 2019/03/08
	Signature:	HIPOKARO HAGKIIMOJO
00	***************************************	

Attorney Docket No.: Sony Ref. No.: \$P366929U800

## DECLARATION (37 CFR 1.63) FOR UTILITY OR DESIGN APPLICATION USING AN APPLICATION DATA SHEET (37 CFR 1.76) AND ASSIGNMENT FOR MULTIPLE ASSIGNEES

As the below named inventor, it hereby declare that:  This declaration is directed to:  The attached application, or  United States application or PCT international application number PCT/JP2017/029610  filed on 2017/08/18  The above-identified application was made or authorized to be made by me.  I believe that I am the original inventor or an original joint inventor of a claimed invention in the application.  SONY CORPORATION  WHEREAS, SONY SEMICONDUCTOR SOLUTIONS CORPORATION  WHEREAS, SONY SEMICONDUCTOR SOLUTIONS CORPORATION  WHEREAS, SONY SEMICONDUCTOR SOLUTIONS CORPORATION  1-7-1 KONAN, MINATO-KU, TOKYO, 108-0075, JAPAN,  4-14-1 Asahi-cho, Atsugi-shi, Kanagawa, Japan  respectively (hereinafter referred to as ASSIGNESS), are destrous of jointly acquiring all interest in, to and under said invention, said application disclosing the invention and in, to and under any Letters Patent or similar legal protection which may be granted therefor in the United States and in any and all foreign countries.  NOW THEREFORE, in consideration of the sum of One Doliar (\$1.00), and other good and valuable consideration, the receipt and sufficiency of which are hereby acknowledged, I by these presents do hereby assign, sell and transfer unto said ASSIGNES, their successors, assigns, and legal representatives, the entire right, title and interest in said invention, said application, including any divisions and continuations thereof, and in and to any and all Letters Patent of the United States, and countries foreign thereto, which may be granted for said invention, and in and to any and all priority rights and/or convention rights under the International Convention for the Protection of Industrial Property, Inter-American Convention Relating to Patents, Designs and Industrial Models, and any other insentional agreements to which the United States of America adheres, and to any other benefits accraing or to accrue to me with respect to the filing of applications for patents or securing of patents in the United States and counte
United States application or PCT international application number PCT/JP2017/029610  filed on 2017/08/18  The above-identified application was made or authorized to be made by me.  I believe that I am the original inventor or an original joint inventor of a claimed invention in the application.  SONY CORPORATION  WHEREAS, SONY SEMICONDUCTOR SOLUTIONS CORPORATION  WHEREAS, SONY SEMICONDUCTOR SOLUTIONS CORPORATION  1-7-1 KONAN, MINATO-KU, TOKYO, 108-0075, JAPAN,  4-14-1 Asahi-cho, Atsigi-chi, Kanagawa, Japan  respectively (hereinafter referred to as ASSIGNEES), are desirous of jointly acquiring all interest in, to and under said invention, said application disclosing the invention and in, to and under any Letters Patent or similar legal protection which may be granted therefor in the United States and in any and all foreign countries.  NOW THEREFORE, in consideration of the sum of One Dollar (\$1.00), and other good and valuable consideration, the receipt and sufficiency of which are hereby acknowledged, I by these presents do hereby assign, sell and transfer unto said ASSIGNEES, their successors, assigns, and legal representatives, the entire right, title and interest in said invention, and application for the Protection of Industrial Property, Inter-American Convention Relating to Patents, Designs and Industrial Models, and any other international agreements to which the United States of America adheres, and to any other benefits accruing or to accrue to me with respect to the filting of applications for patents or securing of patents in the United States and countries foreign thereto, and i hereby authorize and request the Commissioner of Patents to issue said United States Letters Patent to said ASSIGNEES, as the assignees of the whole right, title and interest thereto;  And I further agree to execute all necessary or desirable and lawful future documents, including assignments in flavor of said ASSIGNEES or their designees, and legal representatives may from time-to-time present to me and without
The above-identified application was made or authorized to be made by me.  I believe that I am the original inventor or an original joint inventor of a claimed invention in the application.  SONY CORPORATION  WHEREAS, SONY SEMICONDUCTOR SOLUTIONS CORPORATION  WHEREAS, SONY SEMICONDUCTOR SOLUTIONS CORPORATION  with offices at 1-7-1 KONAN, MINATO-KU, TOKYO, 108-0075, JAPAN, 4-14-1 Asahi-cho, Atsugi-shi, Kanagawa, Japan  respectively (herainafter referred to as ASSIGNEES), are desirous of jointly acquiring all interest in, to and under said invention, said application disclosing the invention and in, to and under any Letters Patent or similar legal protection which may be granted therefor in the United States and in any and all foreign countries.  NOW THEREFORE, in consideration of the sum of One Dollar (\$1.00), and other good and valuable consideration, the receipt and sufficiency of which are hereby acknowledged, I by these presents do hereby assign, sell and transfer unto said ASSIGNEES, their successors, assigns, and legal representatives, the entire right, title and interest in said invention, said application, including any divisions and continuations thereof, and in and to any and all Letters Patent of the United States, and countries foreign thereto, which may be granted for said invention, and in and to any and all priority rights and/or convention rights under the International Convention for the Protection of Industrial Property, Inter-American Convention Relating to Patents, Designs and Industrial Models, and any other international agreements to which the United States of America adheres, and to any other benefits accruing or to accrue to me with respect to the filting of applications for patents or securing of patents in the United States and countries foreign thereto, and I hereby authorize and request the Commissioner of Patents to issue said United States Letters Patent to said ASSIGNEES or their successors, assigns and legal representatives may from time-to-time present to me and without
Ibelieve that I am the original inventor or an original joint inventor of a claimed invention in the application.  SONY CORPORATION  WHEREAS.  SONY SEMICONDUCTOR SOLUTIONS CORPORATION  1-7-1 KONAN, MINATO-KU, TOKYO, 108-0075, JAPAN, 4-14-1 Asahi-cho, Atsugi-shi, Kanagawa, Japan  respectively (hereinafter referred to as ASSIGNEES), are destrous of jointly acquiring all interest in, to and under said invention, said application disclosing the invention and in, to and under any Letters Patent or similar legal protection which may be granted therefor in the United States and in any and all foreign countries.  NOW THEREFORE, in consideration of the sum of One Dollar (\$1.00), and other good and valuable consideration, the receipt and sufficiency of which are hereby acknowledged, I by these presents do hereby assign, sell and transfer unto said ASSIGNEES, their successors, assigns, and legal representatives, the entire right, title and interest in said invention, said application, including any divisions and continuations thereof, and in and to any and all Letters Patent of the United States, and countries foreign thereto, which may be granted for said invention, and in and to any and all priority rights and/or convention rights under the International Convention for the Protection of Industrial Property, Inter-American Convention Relating to Patents, Designs and Industrial Models, and any other international agreements to which the United States of America adheres, and to any other benefits accruing or to accrue to me with respect to the filling of applications for patents or securing of patents in the United States and countries foreign thereto, and I hereby authorize and request the Commissioner of Patents to issue said United States Letters Patent to said ASSIGNEES or their successors, assigns and legal representatives may from time-to-time present to me and without
WHEREAS. SONY SEMICONDUCTOR SOLUTIONS CORPORATION  1-7-1 KONAN, MINATO-KU, TOKYO, 108-0075, JAPAN, 4-14-1 Asahi-cho, Atsugi-shi, Kanagawa, Japan  respectively (hereinafter referred to as ASSIGNEES), are destrous of jointly acquiring all interest in, to and under said invention, said application disclosing the invention and in, to and under any Letters Patent or similar legal protection which may be granted therefor in the United States and in any and all foreign countries.  NOW THEREFORE, in consideration of the sum of One Dollar (\$1.00), and other good and valuable consideration, the receipt and sufficiency of which are hereby acknowledged, I by these presents do hereby assign, sell and transfer unto said ASSIGNEES, their successors, assigns, and legal representatives, the entire right, title and interest in said invention, said application, including any divisions and continuations thereof, and in and to any and all Letters Patent of the United States, and countries foreign thereto, which may be granted for said invention, and in and to any and all priority rights and/or convention rights under the international Convention for the Protection of Industrial Property, Inter-American Convention Relating to Patents, Designs and Industrial Models, and any other international agreements to which the United States of America adheres, and to any other benefits accruing or to accrue to me with respect to the filling of applications for patents or securing of patents in the United States and countries foreign thereto, and I hereby authorize and request the Commissioner of Patents to issue said United States Letters Patent to said ASSIGNEES, as the assignees of the whote right, title and interest thereto;  And I further agree to execute all necessary or desirable and lawful future documents, including assignments in favor of said ASSIGNEES or their designee(s), as ASSIGNEES or their successors, assigns and legal representatives may from time-to-time present to me and without
WHEREAS. SONY SEMICONDUCTOR SOLUTIONS CORPORATION  1-7-1 KONAN, MINATO-KU, TOKYO, 108-0075, JAPAN, 4-14-1 Asahi-cho, Atsugi-shi, Kanagawa, Japan  respectively (hereinafter referred to as ASSIGNEES), are destrous of jointly acquiring all interest in, to and under said invention, said application disclosing the invention and in, to and under any Letters Patent or similar legal protection which may be granted therefor in the United States and in any and all foreign countries.  NOW THEREFORE, in consideration of the sum of One Dollar (\$1.00), and other good and valuable consideration, the receipt and sufficiency of which are hereby acknowledged, I by these presents do hereby assign, sell and transfer unto said ASSIGNEES, their successors, assigns, and legal representatives, the entire right, title and interest in said invention, said application, including any divisions and continuations thereof, and in and to any and all Letters Patent of the United States, and countries foreign thereto, which may be granted for said invention, and in and to any and all priority rights and/or convention rights under the international Convention for the Protection of Industrial Property, Inter-American Convention Relating to Patents, Designs and Industrial Models, and any other international agreements to which the United States of America adheres, and to any other benefits accruing or to accrue to me with respect to the filling of applications for patents or securing of patents in the United States and countries foreign thereto, and I hereby authorize and request the Commissioner of Patents to issue said United States Letters Patent to said ASSIGNEES, as the assignces of the whole right, title and interest thereto;  And I further agree to execute all necessary or desirable and tawful future documents, including assignments in favor of said ASSIGNEES or their successors, assigns and legal representatives may from time-to-time present to me and without
1-7-1 KONAN, MINATO-KU, TOKYO, 108-0075, JAPAN. 4-14-1 Asahi-cho, Atsugi-shi, Kanagawa, Japan respectively (hereinafter referred to as ASSIGNEES), are desirous of jointly acquiring all interest in, to and under said invention, said application disclosing the invention and in, to and under any Letters Patent or similar legal protection which may be granted therefor in the United States and in any and all foreign countries.  NOW THEREFORE, in consideration of the sum of One Dollar (\$1.00), and other good and valuable consideration, the receipt and sufficiency of which are hereby acknowledged, I by these presents do hereby assign, sell and transfer unto said ASSIGNEES, their successors, assigns, and legal representatives, the entire right, title and interest in said invention, said application, including any divisions and continuations thereof, and in and to any and all Letters Patent of the United States, and countries foreign thereto, which may be granted for said invention, and in and to any and all priority rights and/or convention rights under the International Convention for the Protection of Industrial Property, Inter-American Convention Relating to Patents, Designs and Industrial Models, and any other international agreements to which the United States of America adheres, and to any other benefits accruing or to accrue to me with respect to the filting of applications for patents or securing of patents in the United States and countries foreign thereto, and I hereby authorize and request the Commissioner of Patents to issue said United States Letters Patent to said ASSIGNEES, as the assignces of the whole right, title and interest thereto;  And I further agree to execute all necessary or desirable and lawful future documents, including assignments in favor of said ASSIGNEES or their designee(s), as ASSIGNEES or their successors, assigns and legal representatives may from time-to-time present to me and without
respectively (hereinafter referred to as ASSIGNEES), are destrous of jointly acquiring all interest in, to and under said invention, said application disclosing the invention and in, to and under any Letters Patent or similar legal protection which may be granted therefor in the United States and in any and all foreign countries.  NOW THEREFORE, in consideration of the sum of One Dollar (\$1.00), and other good and valuable consideration, the receipt and sufficiency of which are hereby acknowledged, I by these presents do hereby assign, sell and transfer unto said ASSIGNEES, their successors, assigns, and legal representatives, the entire right, title and interest in said invention, said application, including any divisions and continuations thereof, and in and to any and all Letters Patent of the United States, and countries foreign thereto, which may be granted for said invention, and in and to any and all priority rights and/or convention rights under the International Convention for the Protection of Industrial Property, Inter-American Convention Relating to Patents, Designs and Industrial Models, and any other international agreements to which the United States of America adheres, and to any other benefits accruing or to accrue to me with respect to the filting of applications for patents or securing of patents in the United States and countries foreign thereto, and I hereby authorize and request the Commissioner of Patents to issue said United States Letters Patent to said ASSIGNEES, as the assignces of the whole right, title and interest thereto;  And I further agree to execute all necessary or desirable and lawful future documents, including assignments in favor of said ASSIGNEES or their designee(s), as ASSIGNEES or their successors, assigns and legal representatives may from time-to-time present to me and without
application disclosing the invention and in, to and under any Letters Patent or similar legal protection which may be granted therefor in the United States and in any and all foreign countries.  NOW THEREFORE, in consideration of the sum of One Dollar (\$1.00), and other good and valuable consideration, the receipt and sufficiency of which are hereby acknowledged, I by these presents do hereby assign, sell and transfer unto said ASSIGNEES, their successors, assigns, and legal representatives, the entire right, title and interest in said invention, said application, including any divisions and continuations thereof, and in and to any and all Letters Patent of the United States, and countries foreign thereto, which may be granted for said invention, and in and to any and all priority rights and/or convention rights under the International Convention for the Protection of Industrial Property, Inter-American Convention Relating to Patents, Designs and Industrial Models, and any other international agreements to which the United States of America adheres, and countries foreign thereto, and I hereby authorize and request the filting of applications for patents or securing of patents in the United States and countries foreign thereto, and I hereby authorize and request the Commissioner of Patents to issue said United States Letters Patent to said ASSIGNEES, as the assignces of the whole right, title and interest thereto;  And I further agree to execute all necessary or desirable and lawful future documents, including assignments in favor of said ASSIGNEES or their successors, assigns and legal representatives may from time-to-time present to me and without
of which are hereby acknowledged, I by these presents do hereby assign, sell and transfer unto said ASSIGNEES, their successors, assigns, and legal representatives, the entire right, title and interest in said invention, said application, including any divisions and continuations thereof, and in and to any and all Letters Patent of the United States, and countries foreign thereto, which may be granted for said invention, and in and to any and all priority rights and/or convention rights under the International Convention for the Protection of Industrial Property, Inter-American Convention Relating to Patents, Designs and Industrial Models, and any other international agreements to which the United States of America adheres, and to any other benefits accruing or to accrue to me with respect to the filing of applications for patents or securing of patents in the United States and countries foreign thereto, and I hereby authorize and request the Commissioner of Patents to issue said United States Letters Patent to said ASSIGNEES, as the assignces of the whole right, title and interest thereto;  And I further agree to execute all necessary or desirable and lawful future documents, including assignments in favor of said ASSIGNEES or their designee(s), as ASSIGNEES or their successors, assigns and legal representatives may from time-to-time present to me and without
their designee(s), as ASSIGNEES or their successors, assigns and legal representatives may from time-to-time present to me and without
further remuneration, in order to perfect title in said invention, modifications, and improvements in said invention, applications and Leiters Patent of the United States and countries foreign thereto;
And I further agree to properly execute and deliver and without further remuneration, such necessary or desirable and lawful papers for application for foreign patents, for filing subdivisions of said application for patent, and or, for obtaining any reissue or reissues of any Letters patent which may be granted for my aforesaid invention, as said ASSIGNEES thereof shall hereafter require and prepare at their own expense;
And I further agree that ASSIGNEES will, upon their request, be provided promptly with all pertinent facts and documents relating to said application, said invention and said Letters Patent and legal equivalents in foreign countries as may be known and accessible to me and will testify as to the same in any interference or litigation related thereto.
And I hereby covenant that no assignment, sale, agreement or encumbrance has been or will be made or entered into which would conflict with this assignment and sale.
I hereby acknowledge that any willful false statement made in this declaration is punishable under 18 U.S.C. 1001 by fine or imprisonment of not more than five (5) years, or both.
LEGAL NAME OF INVENTOR
Invensor: HIROSHI UJI Date: 2019 / 01 / 3
Signature: <u>Howki Uji</u>

**RECORDED: 04/18/2019**